



雙色)	Green	AlGaInP		2.8	3.4	800	1500	520	530	
TM-L03B	Blue	IGaN/Ga	25 °	2.8	3.4	80	100	460	475	20MA
CG-E (	Green	N				800	1500	520	530	
藍、翠綠										
雙色)										
TM-L03O	Orange	AlGaInP	25 °	1.8	2.4	30	60	600	610	20MA
PG-E (	White	IGaN/Ga		2.8	3.4	30	60	565	575	
橙、黃綠		N								
雙色)										

#### Supporter shaping :

Shaping of the supporter must be conducted before welding. While shaping, the bending position of the supporter must at least be located at 3mm from the bottom of the encapsulating resin. Also, avoid multiple bending on the same position. Please choose the appropriate apparatus to fixate the supporter in order to avoid exerting extra pressure on resin. Using the jointing section of the pin and resin as fulcrum is strictly prohibited since the pressure mounted would directly damage the internal illuminating structure and thus cause irreversible deflection of the product. Due to the same reason, the interval between the welding hole on the PCB board should be strictly matched with the pin interval of the product when assembling the product.